TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIII)

2SK3301

Switching Regulatorand DC-DC Converter Applications

Low drain-source ON resistance: R_{DS} (ON) = 15 Ω (typ.)

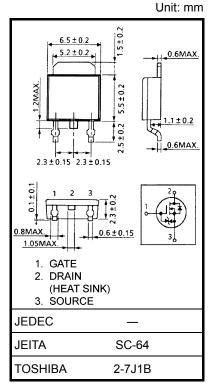
• High forward transfer admittance: |Yfs| = 0.65 S (typ.)

Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 720 V)

• Enhancement mode: V_{th} = 2.4 to 3.4 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	900	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	900	٧	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	I _D	1	Α	
	Pulse (Note 1)	I _{DP}	2		
Drain power dissipati	on (Tc = 25°C)	P_{D}	20	W	
Single pulse avalanche energy (Note 2)		E _{AS}	140	mJ	
Avalanche current		I _{AR}	1	Α	
Repetitive avalanche	energy (Note 3)	E _{AR}	2.0	mJ	
Channel temperature	•	T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55 to 150	°C	



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 257 mH, $R_G = 25 \Omega$,

Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

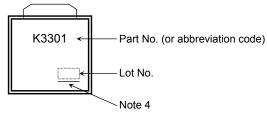
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	kdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off current		I _{DSS}	V _{DS} = 720 V, V _{GS} = 0 V	_	_	100	μА
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	900	_	_	V
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.4	_	3.4	V
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 0.5 A	_	15	20	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ A}$	0.3	0.65	_	S
Input capacitance		C _{iss}		_	165	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	6	_	pF
Output capacitance		Coss		_	21	_	pF
Switching time	Rise time	t _r	V _{GS} 0 V	_	15	_	
	Turn-on time	t _{on}		_	60	_	ne
	Fall time	t _f		l	40	_	ns
	Turn-off time	t _{off}	Duty \leq 1%, $t_W = 10 \mu s$		110	_	
Total gate charge (gate-source plus gate-drain)		Qg	V 400 V V 40 V I- 4 A	_	6	_	nC
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$	_	3	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	3	_	nC

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	1	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	2	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 1 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 1 A, V _{GS} = 0 V	_	1300		ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs	_	1.95	_	μС

Marking



Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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